

CLSE

# 2026深圳国际 工业洁净大会暨展览会

INDUSTRIAL CLEANLINESS CONFERENCE AND EXHIBITION

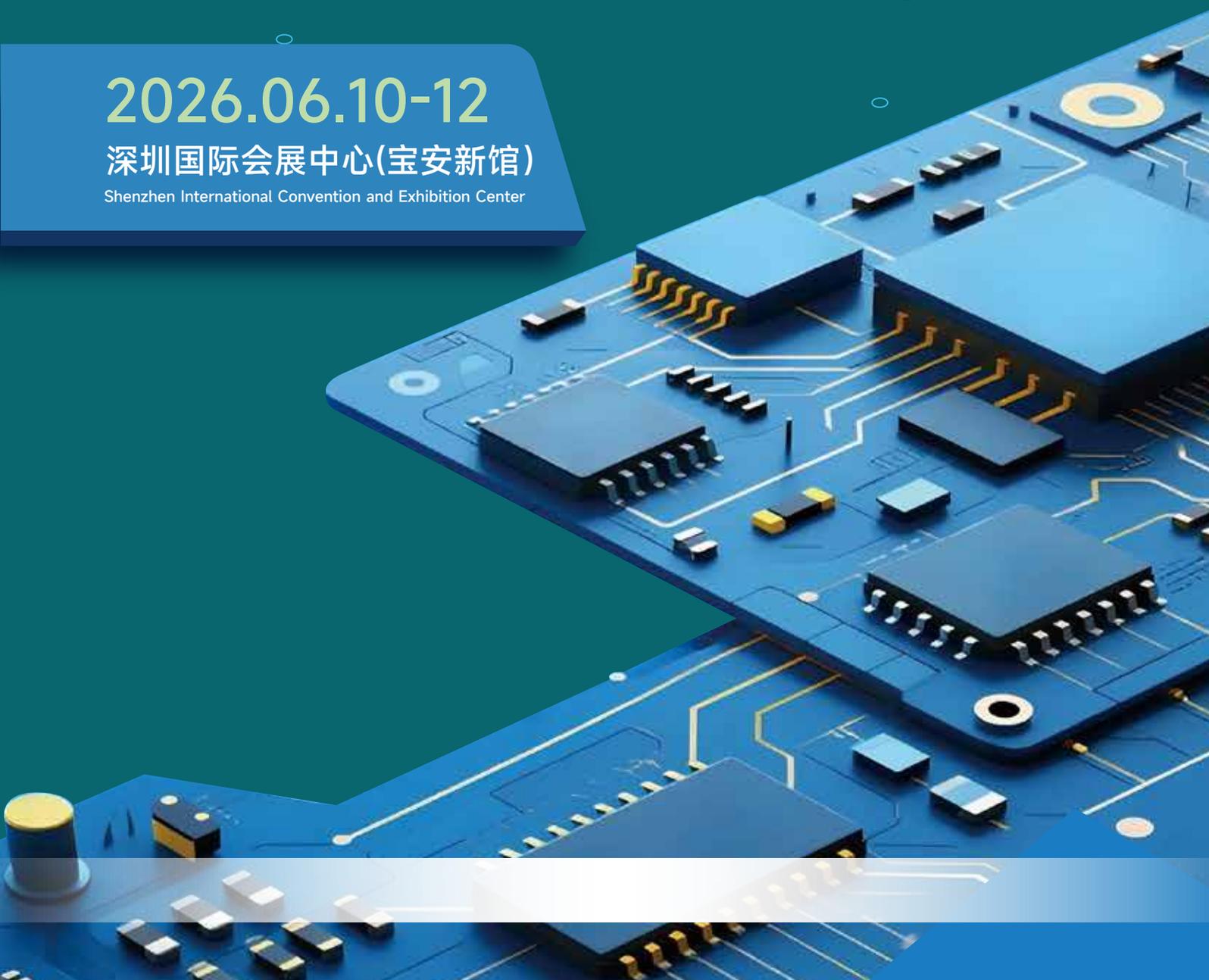
同期举办：2026中国(深圳)国际半导体展览会

2026 CHINA (SHENZHEN) INTERNATIONAL SEMICONDUCTOR EXHIBITION

2026.06.10-12

深圳国际会展中心(宝安新馆)

Shenzhen International Convention and Exhibition Center





## 展会介绍 EXHIBITION BACKGROUND

半导体与集成电路产业是科技竞争的“战略高地”、产业升级的“核心引擎”，而工业洁净技术作为其核心配套保障，是产业高质量发展的关键基石。随着全球数字化转型加速，两者的协同价值愈发凸显。深圳已实现半导体产业从零起步到全链条突破的跨越式发展，构建起涵盖设计、制造、封测、设备、材料等环节的完整产业链，形成“政策 - 资本 - 人才 - 技术”四轮驱动的发展模式，成为国内半导体产业创新发展的核心高地。工业洁净技术已深度融入半导体全制程，为芯片制造的精密性、稳定性及产品良率提供不可或缺的支撑。

深圳高度重视产业协同发展，通过构建“一基金、一展会、一论坛”等“六个一”产业生态体系，出台系列普惠性政策，覆盖核心技术攻关、公共服务平台建设、创新成果转化等全周期。设立首期规模 50 亿元的产业投资基金，精准投向产业链关键领域与薄弱环节；同时搭建“湾芯展”等专业协作平台，推动半导体与工业洁净技术深度融合，加速产业升级。

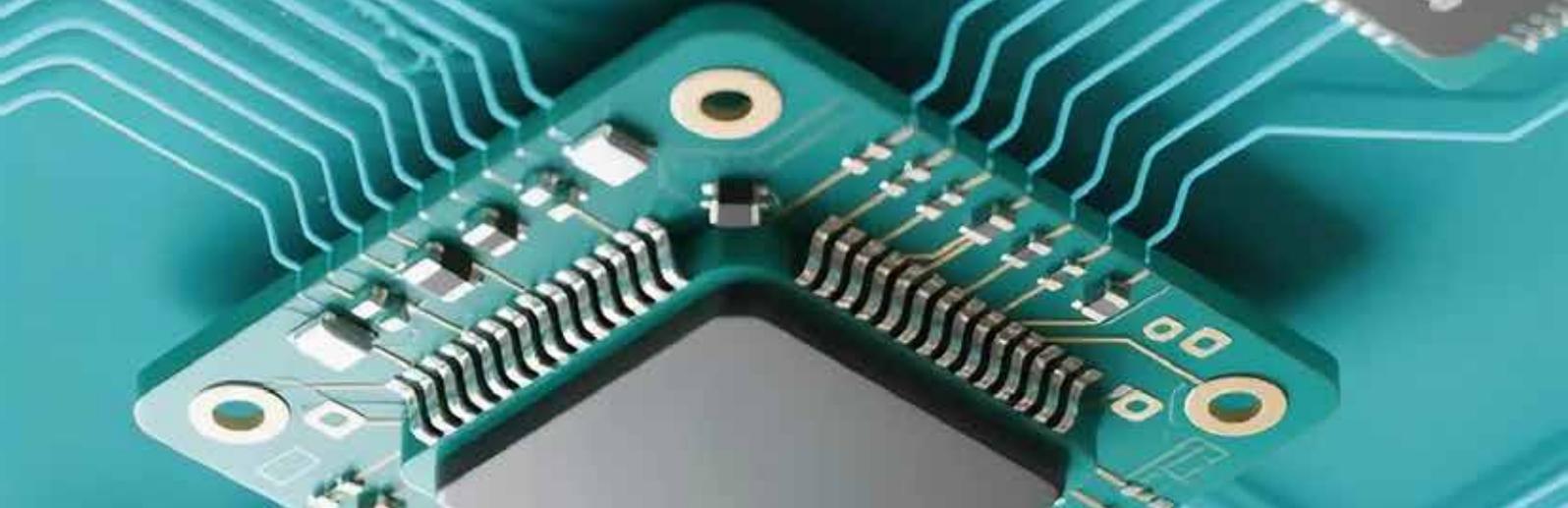
2024 年深圳半导体与集成电路产业规模达 2564 亿元，同比增长 26.8%；2025 年上半年持续高增，产业规模 1424 亿元，同比增长 16.9%。目前全市集聚海思、新凯来、睿思芯科等上下游优质企业，制造、封测、设备等细分领域规模较 2020 年实现倍增，在车规级碳化硅芯片、CPU、半导体设备等领域实现国产化突破。相关产品广泛服务于消费电子、汽车电子、人工智能等领域，而工业洁净技术的持续创新，正与半导体产业协同发力，共同为深圳打造全球重要影响力的产业创新高地注入强劲动能。

The semiconductor and integrated circuit industry is a "strategic high ground" for technological competition and a "core engine" for industrial upgrading, while industrial clean technology, as its core supporting guarantee, is a key cornerstone for the high-quality development of the industry. With the acceleration of global digital transformation, the collaborative value of the two has become increasingly prominent. Shenzhen has achieved a leapfrog development of the semiconductor industry from scratch to full-chain breakthroughs, building a complete industrial chain covering design, manufacturing, packaging and testing, equipment, materials and other links. It has formed a "policy-capital-talent-technology" four-wheel drive development model, becoming a core highland for the innovative development of China's semiconductor industry. Industrial clean technology has been deeply integrated into the entire semiconductor manufacturing process, providing indispensable support for the precision, stability and product yield of chip manufacturing.

Shenzhen attaches great importance to the coordinated development of the industry. By building a "six ones" industrial ecological system including "one fund, one exhibition, one forum", it has issued a series of inclusive policies covering the entire cycle of core technology research, public service platform construction, and innovation achievement transformation. A first-phase industrial investment fund of 5 billion yuan has been established, which is accurately invested in the key areas and weak links of the industrial chain; at the same time, professional cooperation platforms such as the "Bay Chip Exhibition" have been built to promote the in-depth integration of semiconductor and industrial clean technology and accelerate industrial upgrading.

In 2024, the scale of Shenzhen's semiconductor and integrated circuit industry reached 256.4 billion yuan, a year-on-year increase of 26.8%; it maintained rapid growth in the first half of 2025, with an industrial scale of 142.4 billion yuan, a year-on-year increase of 16.9%. At present, the city has gathered high-quality upstream and downstream enterprises such as HiSilicon, Xinkailai, and Ruisixinke. The scale of manufacturing, packaging and testing, equipment and other subdivisions has doubled compared with 2020, and domestic breakthroughs have been achieved in fields such as automotive-grade silicon carbide chips, CPUs, and semiconductor equipment. Related products are widely used in consumer electronics, automotive electronics, artificial intelligence and other fields. The continuous innovation of industrial clean technology, together with the semiconductor industry, is jointly injecting strong momentum into Shenzhen's efforts to build an industrial innovation highland with global important influence.

ESTO



## 新的机遇 NEW OPPORTUNITIES

为给更多半导体与集成电路企业及工业洁净领域相关企业，搭建集产品展示、贸易洽谈、技术交流、投资合作于一体的国际化平台，将于 2026 年 06 月 10 日 - 12 日在深圳举办“2026 国际（深圳）半导体展览会暨国际工业洁净技术与设备展览会”。

展会以“芯净协同，智造新机遇”为主题，展品实现双领域全链条覆盖：一方面涵盖半导体关键设备及零部件、半导体材料、EDA&IP、集成电路设计、制造、封装测试、半导体服务、芯片应用等核心产品与技术；另一方面聚焦半导体产业洁净刚需，展示洁净室工程及设备、空气净化系统、防静电 / 防微振产品、超纯水 / 超纯气体处理设备、洁净检测与认证服务等配套解决方案。

本届展会将汇聚全球半导体与集成电路行业尖端技术、前沿产品，以及工业洁净领域的创新成果，从芯片设计、制造到洁净保障、应用落地，全方位呈现两大领域的协同创新力量。依托深圳“政策 - 资本 - 人才 - 技术”四轮驱动的产业生态优势，通过“展览 + 论坛”的形式，多视角展现中国（尤其是粤港澳大湾区）半导体产业创新实力、发展成果及工业洁净技术的支撑价值，分享产业前沿动态、汇聚创新人才、促进技术交流合作、推动产业生态构建。

展会将进一步打通半导体创新链、产业链、供应链与工业洁净配套体系的深度融合，为上下游企业搭建精准对接的国际化桥梁，助力深圳打造具有全球重要影响力的产业创新高地，推动我国半导体与集成电路产业高质量发展。

To build an international platform integrating product display, trade negotiations, technical exchanges, and investment cooperation for more semiconductor and integrated circuit enterprises as well as those in the industrial clean technology sector, the "2026 International (Shenzhen) Semiconductor Exhibition & International Industrial Clean Technology and Equipment Exhibition" will be held in Shenzhen from June 10 to 12, 2026.

With the theme of "Synergy of Chips and Cleanliness, Creating New Opportunities for Intelligent Manufacturing", the exhibition's exhibits fully cover the entire industrial chains of two key fields. On one hand, it includes core products and technologies across the semiconductor industry chain, such as key semiconductor equipment and components, semiconductor materials, EDA&IP, integrated circuit design, manufacturing, packaging and testing, semiconductor services, and chip applications. On the other hand, it focuses on the essential clean technology needs of the semiconductor industry, showcasing supporting solutions including cleanroom engineering and equipment, air purification systems, anti-static/anti-microvibration products, ultrapure water/ultrapure gas treatment equipment, and cleanroom testing and certification services.

This exhibition will gather cutting-edge technologies and advanced products from the global semiconductor and integrated circuit industry, as well as innovative achievements in the industrial clean technology field. From chip design and manufacturing to clean technology support and application implementation, it comprehensively presents the collaborative innovation power of the two sectors. Leveraging Shenzhen's industrial ecological advantages driven by the "four wheels" of policy, capital, talent, and technology, the exhibition adopts a "display + forum" format to multi-dimensionally demonstrate the innovation strength and development achievements of China's semiconductor industry (especially in the Guangdong-Hong Kong-Macao Greater Bay Area) and the supporting value of industrial clean technology. It shares the latest industry trends, gathers innovative talents, promotes technical exchanges and cooperation, and facilitates the construction of an industrial ecosystem.

The exhibition will further deepen the integration of the semiconductor innovation chain, industrial chain, supply chain with the industrial clean technology supporting system, building an international bridge for precise docking between upstream and downstream enterprises. It will help Shenzhen become an industrial innovation highland with significant global influence and drive the high-quality development of China's semiconductor and integrated circuit industry.

# ESTO CLEAN

## 同期活动 CONCURRENT ACTIVITIES

展会同期将举办半导体与集成电路产业发展高峰论坛、技术交流会、投融资对接会、产品首发首秀等多场专业活动，集聚顶尖专家、企业高管与投资机构，深度探讨全球半导体和集成电路发展趋势与关键应用场景。期间，多场半导体全产业链与具身智能、人工智能、物联网、仪器仪表、新能源汽车、网络通信、消费电子等领域的供需对接会将作为展会的最大的亮点，对接会以采购商与参展商通过交流对接完成产品细节的交流与信息的收集，旨在推动产业链上下游企一面对面交流形式进行，业之间的精准商务合作。

During the exhibition, a series of professional events will be held, including the Semiconductor and Integrated Circuit Industry Development Summit Forum, Technical Exchange meetings, Investment and Financing Matchmaking Conferences, and product launches and debuts. These events will gather top experts, corporate executives, and investment institutions to deeply discuss the global development trends and key application scenarios of semiconductors and integrated circuits. During this period, multiple supply and demand matching events covering the entire semiconductor industry chain and fields such as embedded intelligence, artificial intelligence, the Internet of Things, instruments and meters, new energy vehicles, network communications, and consumer electronics will be the biggest highlights of the exhibition. These matching events enable buyers and exhibitors to exchange product details and collect information through communication and matching. It aims to promote precise business cooperation between upstream and downstream enterprises in the industrial chain through face-to-face communication.



# CLSE

## 展品大类 MAJOR EXHIBITS

**IC设计:** IC设计 (模拟和功率芯片、AI算力芯片、存储芯片、汽车电子芯片、智能家电芯片、人工智能芯片、ASIC芯片、传感器芯片、光电芯片、生物芯片、类脑芯片、量子芯片) ;

IC Design: IC design (analog and power chips, ai computing chips, memory chips, automotive electronics chips, smart home appliance chips, AI chips, asic chips, sensor chips, photonic chips, biochips, neuromorphic chips, quantum chips);

**IC制造:** 晶圆制造、分立器件、光电器件、传感器产品;

IC Manufacturing: Wafer fabrication, discrete devices, optoelectronic devices, sensor products;

**IC封装及测试:** DIP、SOP、QFP、SIP、BGA等传统封装; 倒装、晶圆级封装、2.5D/3D先进封装(TSV及TGV)、Chiplet等先进封装; IC前后端测试服务;

IC Packaging and Testing: Traditional packaging (DIP, SOP, QFP, SIP, BGA); advanced packaging (flip-chip, wafer-level packaging, 2.5d/3d packaging with tsv and tgv, chiplet technology); ic testing services (front-end and back-end)

**EDA&IP;**

## 展品大类 MAJOR EXHIBITS

**洁净室设备:** 医疗净化、生物制药净化、电子净化、洁净工作台、洁净棚/柜、FFU、空气过滤器、净化灯具、生物安全柜、传递箱/窗、空气吹淋室、层流罩、净化吸尘器、电子空气自净、灭菌设备、清洗消毒设备等,

Medical purification, biopharmaceutical purification, electronic purification, clean workbenches, clean booths/cabinets, FFUs, air filters, purification lamps, biosafety cabinets, transfer boxes/Windows, air showers, laminar flow hoods, purification vacuum cleaners, electronic air self-cleaning, sterilization equipment, cleaning and disinfection equipment, etc.

**HVAC系统:** 中央调整机、配套产品及附件, 净化空调、风机、自控产品、控制中心及系统等,

Central air conditioning complete machines, supporting products and accessories, purification air conditioning, fans, automatic control products, control centers and systems, etc.

**洁净室构架:** 顶棚/天花、龙骨、壁板、地坪、涂料及地板、门、窗及玻璃、彩钢板、净化铝材等;

Ceiling/ceiling, keel, wall panels, floor, paint and flooring, doors, Windows and glass, color steel plates, purified aluminum materials

**洁净室用品:** 防静电防尘净化服(帽、衣、裤、鞋、靴、防护目镜/罩、手套)、净化室用纸、笔, 无尘纸、无尘抹布、净化棉签等耗材;滤材滤料;防静电手腕带、防静电台垫、防静电无尘椅等;

Anti-static and dust-proof purification clothing (hats, clothes, pants, shoes, boots, protective goggles/covers, gloves), purification room paper and pens, dust-free paper, dust-free cloths, purification cotton swabs and other consumables: filter materials and filter media; Anti-static wrist straps, anti-static floor MATS, anti-static dust-free chairs, etc.

**实验室设备:** 通风柜、中央台、边台、实验台、功能柜、药品柜、器皿柜、天平台、不锈钢衣柜、鞋柜、洗手池、换鞋凳、水槽、原子吸收罩、推车、货架、防爆柜、护士站、医疗家具等;

Fume hoods, central benches, side benches, laboratory benches, functional cabinets, medicine cabinets, instrument cabinets, balance tables, stainless steel wardrobes, shoe cabinets, washbasins, shoe-changing stools, sinks, atomic absorption hoods, trolleys, shelves, explosion-proof cabinets, nurse stations, medical furniture, etc.

**检测仪器仪表:** 测定仪器、粒子计数器、采样器、风量罩、压差表、静电测试分析仪、监测系统

Measuring instruments Particle counter Samplers, air volume hoods, differential pressure gauges, electrostatic test analyzers, monitoring systems, etc

**物料供应:** 纯水设备、超纯水处理设备、工业废水处理设备、超纯气、特种气体、化学品等

Pure water equipment, ultra-pure water treatment equipment, industrial wastewater treatment equipment, ultra-pure gas, special gas, chemicals, etc

**设计与认证:** 设计院、设计/工程/装饰/检测公司、GMP制药工程、咨询认证公司协会等

Design institutes, design/engineering/decoration/testing companies, GMP pharmaceutical engineering, consulting and certification company associations, etc

## 展品大类 MAJOR EXHIBITS

**半导体设备及零部件：**晶圆加工过程中所需的各种精密设备、半导体封装设备、测试设备；密封圈、精密轴承、金属零部件、Valve阀、硅/SiC件、Robots、石英件、过滤器、射频电源、陶瓷件、ESC静电吸盘、压力Gauge、泵、MFC流量计、步进马达、运动控制、伺服电机、直线模组、无尘拖链、封装模具、制冷设备、感应加热器等半导体零部件；  
Semiconductor Equipment and Components: Precision equipment for wafer fabrication, semiconductor packaging systems, and test equipment; essential components including sealing rings, precision bearings, metal components, valves, silicon/SiC parts, robots, quartz components, filters, RF power supplies, ceramic components, electrostatic chucks (ESCs), pressure gauges, pumps, mass flow controllers (MFCs), stepper motors, motion control systems, servo motors, linear modules, cleanroom cable carriers, packaging molds, refrigeration equipment, induction heaters, and other critical semiconductor parts;

**半导体材料：**单晶硅、硅片等硅基材料；抛光垫、掩膜版、溅射靶材、光刻胶、薄膜沉积材料、前驱体材料、特种气体、抛光液、湿电子化学品等工艺辅助材料；陶瓷封装材料、键合丝、引线框架、封装基板、塑封材料、高性能塑料等封装材料等；  
Semiconductor Materials: Silicon-based materials including monocrystalline silicon, silicon wafers; process auxiliary materials including polishing pads, photomasks, sputtering targets, photoresists, thin-film deposition materials, precursor materials, specialty gases, polishing slurries, wet electronic chemicals; packaging materials including ceramic packaging materials, bonding wires, lead frames, packaging substrates, molding compounds, high-performance plastics;

**化合物半导体材料及产品：**化合物半导体（如磷化铟、碳化硅、氮化镓、氧化镓等）衬底及外延片材料生产企业及其器件、模组产品；  
Compound Semiconductor Materials and Products: Enterprises specializing in compound semiconductor substrates and epitaxial wafers (e.g., indium phosphide, silicon carbide, gallium nitride, and gallium oxide), along with related devices and module products;

**下游芯片应用：**物联网、人工智能、智能网联汽车、健康医疗、具身智能、消费电子、网络通信、仪器仪表等产品；  
Downstream Chip Applications: The Internet of Things (IoT), AI, intelligent connected vehicles (ICV), healthcare, embodied ai, consumer electronics, network communications, and instrumentation;

**配套设施与服务：**各地芯火平台、半导体协会、产业联盟、半导体研究院、中试产线及高校、投融资机构、环保企业、电子类建筑施工企业、一般商业服务/咨询机构、销售、标准化制定及物流冷链等支撑服务企业。  
Supporting Facilities and Services: Xinhua platform, semiconductor associations, industry alliances, semiconductor research institutes, pilot production lines and universities, investment and financing institutions, environmental protection companies, electronic construction enterprises, general business services/consulting firms, sales organizations, standards development bodies, and logistics and cold chain enterprises.

## 展区设置

## EXHIBITION AREAS

聚焦“高端芯”与“国产替代”的最新突破，打造行业最前沿的技术展示平台。

Focusing on the latest breakthroughs in “high-end chips” and “domestic substitution,” the event strives to provide a cutting-edge platform to showcase industry-leading technologies.

- 1、IC设计 IC Design Pavilion
- 2、IC制造 IC Manufacturing Pavilion
- 3、IC封装及测试 IC Packaging and Testing Pavilio
- 4、EDA&IP EDA&IP Pavilion
- 5、洁净室设备 Cleanroom equipment
- 6、HVAC系统 HVAC system
- 7、洁净室构架 Cleanroom framework
- 8、洁净室用品 Cleanroom supplies
- 9、实验室设备 Laboratory equipment
- 10、检测仪器仪表 Detection instruments and meters
- 11、物料供应 Material supply
- 12、设计与认证 Design and Certification
- 13、半导体设备及零部件Semiconductor Equipment and Components Pavilion
- 14、半导体材料Semiconductor Materials Pavilion
- 15、化合物半导体材料及产品Compound Semiconductors Materials and Products Pavilion
- 16、下游芯片应用Chip Applications Pavilion
- 17、配套设施与服务Supporting Facilities and Services Pavilion

The logo for CLSE (China Lead Semiconductor Exposition) is displayed in a large, white, sans-serif font. The letters 'C', 'L', and 'S' are connected, and the 'E' is separate. The background of the logo area is a blurred image of blue and white circuit traces on a printed circuit board (PCB).

## 参展费用

## PARTICIPATION FEES

★ 标准展位:

A: 国内企业: 标准展位18000RMB/展期 3m×3m

B: 国外企业: 标准展位5200USD/展期 3m×3m

展位包括: 三面白色壁板、中(英)文楣牌制作、咨询桌一张、折椅二把、地毯满铺、展位照明、220V/5A电源插座一个、废纸篓一个。)

★ 室内光地:

A: 国内企业: 2000 (RMB) /平方米

B: 国外企业: 520 (USD) /平方米

注: (最少36平方米起租) “光地” 只提供参展面积, 不包括展架、展具、地毯、电源等。

International Standard Booths:

For overseas enterprises: USD 5200.00/Expo; 3m×3m

Each standard booth consists of 3-sided white wallboards, Chinese& English fascia board, 1 consultation desk, 2 folding chairs, fully-floored carpet, booth lighting system, 1 power socket 220V/5A, and a waste basket.

Indoor Raw Space:

For overseas enterprises: USD 520.00/Sq.m.

Note: The raw space (minimum 36 sq.m.) only supplies a show space excluding stand frames, show equipment, carpet and power supply, etc.



## 观众组织 TARGET AUDIENCES

本次展会将全力邀请全球半导体、集成电路、电子电力、电子制造、显示制造以及汽车、航空航天、医疗卫生、信息通信、消费电子等领域专业人士齐聚杭州，共探前沿科技，共商合作大计，携手解码产业新生态，合力共筑开放、协同、韧性的全球半导体与集成电路产业“芯”未来。

It will attract domestic and foreign professionals from semiconductors, IC, electronic power, electronics manufacturing, display manufacturing, as well as automotive, aerospace, healthcare, information and communications, and consumer electronics industry to participate in the exhibition. The event provides an efficient platform for participants to explore cutting-edge technologies, discuss collaborative strategies, jointly decode the new industrial ecosystem, and work together to build an open, collaborative, and resilient core future for the global semiconductor and IC industry.

# CLSE

## 预定展位 Booth Reservation

请立即预定“CLSE 2026”展位，越早预留位置越佳，争取最大曝光率，领先竞争对手，开拓无限商机。

Your timely reservation will allow us to preassign exhibit space. Requests for exhibit space will be accepted on a “first come, first served” basis.

如欲预订“CLSE 2026”采购交易会展位，可通过以下联络方法，预订展位。

To reserve the booth of “CLSE 2026” or learn more information, please contact:

联系人：张老师

手机/MB: 1379 5333699

添加微信

